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### FQT13N06L N-Channel QFET<sup>®</sup> MOSFET 60 V, 2.8 A, 110 mΩ

#### **General Description**

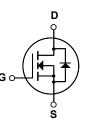
This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor<sup>®</sup>'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications. March 2015

FQT13N06L — N-Channel QFET<sup>®</sup> MOSFET

#### Features

- 2.8 A, 60 V,  $R_{DS(on)}$  = 110 m $\Omega$  (Max.) @V\_{GS} = 10 V, I\_D = 1.4 A
- Low Gate Charge (Typ. 4.8 nC)
- Low Crss (Typ. 17 pF)
- 100% Avalanche Tested





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

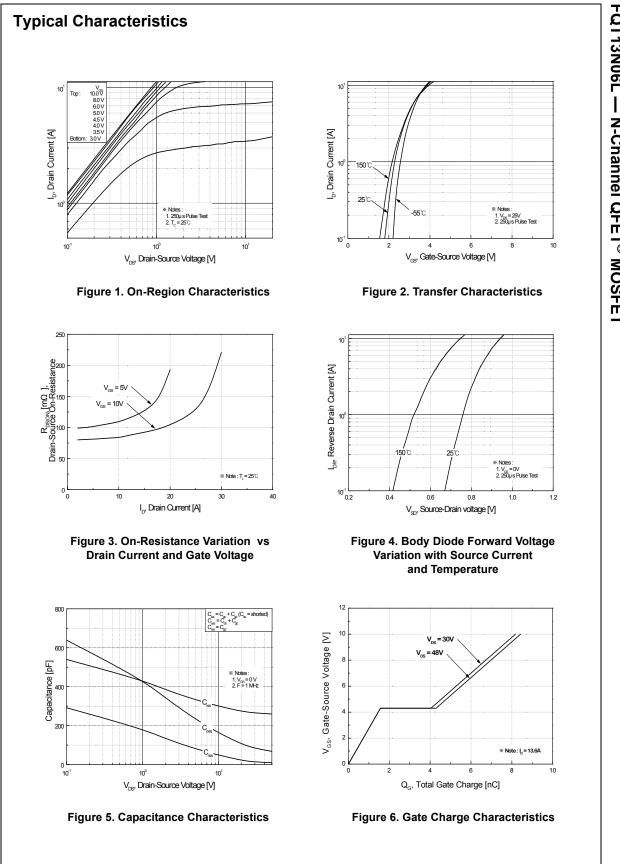
Symbol	Parameter		FQT13N06L	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		60	V	
D	Drain Current - Continuous (T <sub>C</sub> = 25°C)		2.8	Α	
	- Continuous (T <sub>C</sub> = 70°C)		2.24	Α	
DM	Drain Current - Pulsed	(Note 1)	11.2	Α	
/ <sub>GSS</sub>	Gate-Source Voltage		± 20	V	
- AS	Single Pulsed Avalanche Energy (Note 2)		85	mJ	
AR	Avalanche Current	(Note 1)	2.8	А	
AR	Repetitive Avalanche Energy	(Note 1)	0.21	mJ	
lv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns	
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)		2.1	W	
	- Derate above 25°C		0.017	W/°C	
Γ <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
Γ <sub>L</sub>	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

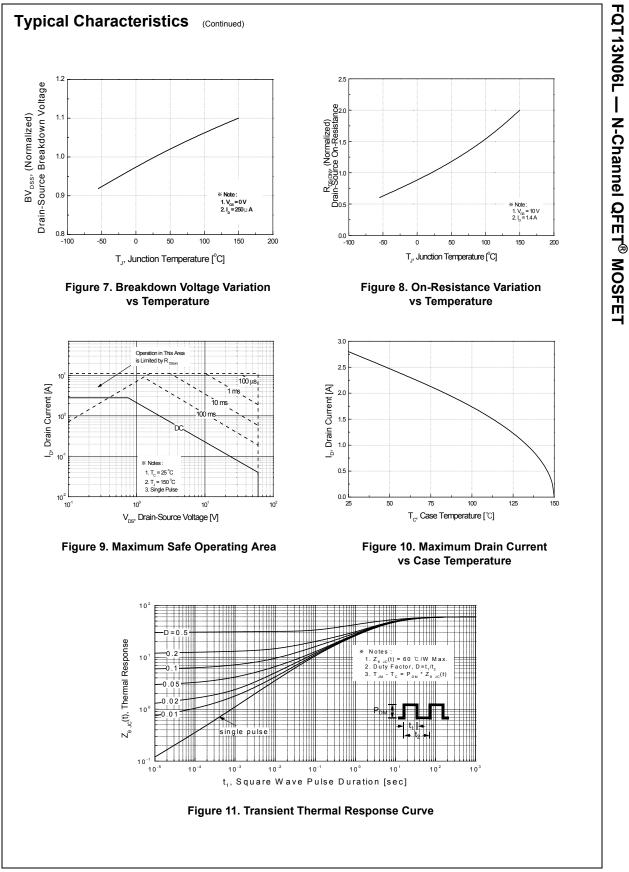
#### **Thermal Characteristics**

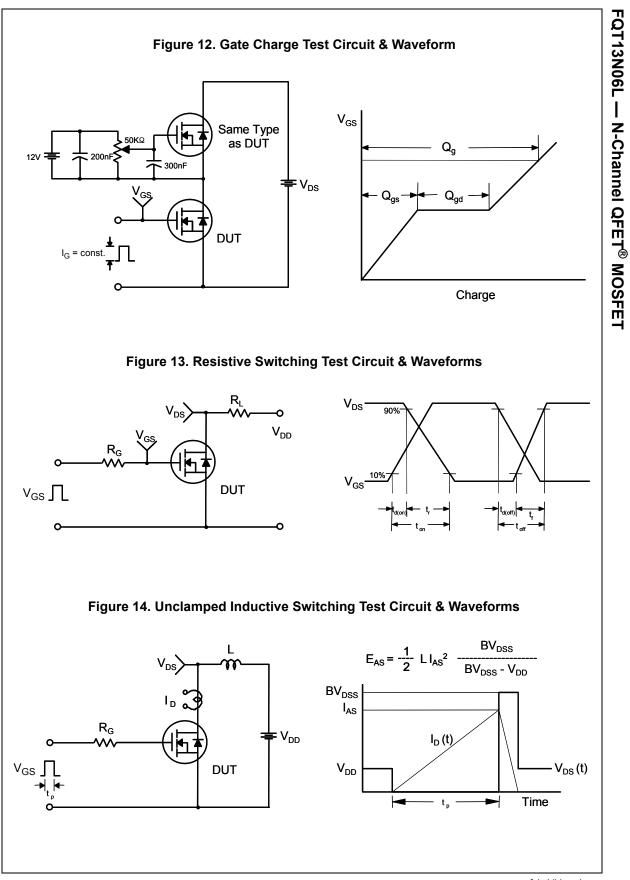
Symbol	Parameter	Тур	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		60	°C/W
* When mounter	ed on the minimum pad size recommended(PCB mount).			

	Test Conditions	\$	Min	Тур	Max	Unit
acteristics						
Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		60			V
Breakdown Voltage Temperature Coefficient		to 25°C		0.05		V/°C
Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V				1	μA
	V <sub>DS</sub> = 48 V, T <sub>C</sub> = 125°C				10	μA
Gate-Body Leakage Current, Forward					100	nA
Gate-Body Leakage Current, Reverse	$V_{GS}$ = -20 V, $V_{DS}$ = 0 V				-100	nA
actoristics						
	Vps = Vcs. lp = 250 µA		10		25	V
ů.			-		-	
On-Resistance	00 0			0.110	0.14	Ω
Forward Transconductance		(Note 4)		4.1		S
				I		
c Characteristics	T			1		
Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,			270	350	pF
	f = 1.0 MHz				-	pF
Reverse Transfer Capacitance				17	23	pF
ng Characteristics				I		1
,	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 6.8 A,			-		ns
	R <sub>G</sub> = 25 Ω					ns
,	-	(Note 4 5)		-		ns
		(1000 4, 3)		-		ns
-				-	-	nC
•	V <sub>GS</sub> = 5 V	(Nata 4 E)				nC
Gate-Drain Charge		(11018 4, 5)		2.7		nC
ource Diode Characteristics ar	nd Maximum Rating	S				
Maximum Continuous Drain-Source Dic	de Forward Current				2.8	Α
Maximum Pulsed Drain-Source Diode F	Forward Current				11.2	Α
Drain-Source Diode Forward Voltage	$V_{GS}$ = 0 V, $I_{S}$ = 2.8 A				1.5	V
Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 13.6 A,			45	-	ns
Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/µs	(Note 4)		45	-	nC
	Coefficient Zero Gate Voltage Drain Current Gate-Body Leakage Current, Forward Gate-Body Leakage Current, Reverse acteristics Gate Threshold Voltage Static Drain-Source On-Resistance Forward Transconductance Characteristics Input Capacitance Reverse Transfer Capacitance Gutput Capacitance Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Maximum Continuous Drain-Source Diode Forward Voltage Drain-Source Diode Forward Voltage	Coefficient $I_D = 250 \ \mu A$ , ReferencedZero Gate Voltage Drain Current $V_{DS} = 60 \ V, V_{GS} = 0 \ V$ Gate-Body Leakage Current, Forward $V_{GS} = 20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = 20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ Gate Threshold Voltage $V_{DS} = 1.4 \ A$ Static Drain-Source $V_{GS} = 5 \ V, \ I_D = 1.4 \ A$ Forward Transconductance $V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \ f = 1.0 \ MHz$ Enput Capacitance $V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \ f = 1.0 \ MHz$ <b>g Characteristics</b> $V_{DD} = 30 \ V, \ I_D = 6.8 \ A, \ R_G = 25 \ \Omega$ Turn-On Delay Time $V_{DS} = 48 \ V, \ I_D = 13.6 \ A, \ V_{GS} = 5 \ V$ Turn-Off Fall Time $V_{DS} = 48 \ V, \ I_D = 13.6 \ A, \ V_{GS} = 5 \ V$ Total Gate Charge $V_{DS} = 5 \ V$ Gate-Source Charge $V_{GS} = 5 \ V$ Gate-Drain Charge $V_{GS} = 5 \ V, \ V_{GS} = 5 \ V, \ V_{GS} = 0 \ V, \ I_S = 2.8 \ A$ Maximum Continuous Drain-Source Diode Forward CurrentMaximum Pulsed Drain-Source Diode Forward Current	Coefficient $I_D = 230 \ \mu A$ , Referenced to $23 \ C$ Zero Gate Voltage Drain Current $V_{DS} = 60 \ V, V_{GS} = 0 \ V$ Gate-Body Leakage Current, Forward $V_{GS} = 20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ acteristicsGate Threshold Voltage $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ Static Drain-Source $V_{GS} = 10 \ V, I_D = 1.4 \ A$ On-Resistance $V_{DS} = 25 \ V, I_D = 1.4 \ A$ Forward Transconductance $V_{DS} = 25 \ V, I_D = 1.4 \ A$ Input Capacitance $V_{DS} = 25 \ V, V_{GS} = 0 \ V,$ f Characteristics $V_{DS} = 25 \ V, V_{GS} = 0 \ V,$ Input Capacitance $V_{DS} = 25 \ V, V_{GS} = 0 \ V,$ f Characteristics $V_{DS} = 25 \ V, V_{GS} = 0 \ V,$ f Characteristics $V_{DS} = 25 \ V, V_{GS} = 0 \ V,$ f Turn-On Delay Time $V_{DD} = 30 \ V, I_D = 6.8 \ A,$ f Turn-Off Delay Time $V_{DS} = 48 \ V, I_D = 13.6 \ A,$ f Cate-Source Charge $V_{SS} = 5 \ V$ Gate-Source Charge $V_{SS} = 5 \ V$ Gate-Drain Charge $V_{OS} = 5 \ V, I_{OS} = 5 \ V,$ Maximum Continuous Drain-Source Diode Forward CurrentMaximum Pulsed Drain-Source Diode Forward CurrentDrain-Source Diode Forward Voltage $V_{GS} = 0 \ V, I_S = 2.8 \ A$	Coefficient $T_D = 250 \ \mu A$ , Referenced to $25 \ C$ Zero Gate Voltage Drain Current $V_{DS} = 60 \ V, V_{GS} = 0 \ V$ Gate-Body Leakage Current, Forward $V_{GS} = 20 \ V, V_{DS} = 0 \ V$ Gate-Body Leakage Current, Reverse $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ acteristics $V_{GS} = -20 \ V, V_{DS} = 0 \ V$ Gate Threshold Voltage $V_{DS} = V_{GS}, \ I_D = 250 \ \mu A$ 1.0Static Drain-Source $V_{GS} = 10 \ V, \ I_D = 1.4 \ A$ On-Resistance $V_{DS} = 25 \ V, \ I_D = 1.4 \ A$ Forward Transconductance $V_{DS} = 25 \ V, \ I_D = 1.4 \ A$ CharacteristicsInput Capacitance $V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \$ Output Capacitance $V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \ f = 1.0 \ MHz$ Turn-On Delay Time $V_{DD} = 30 \ V, \ I_D = 6.8 \ A, \$ Turn-Off Delay Time $V_{DS} = 48 \ V, \ I_D = 13.6 \ A, \$ Turn-Off Fall Time $V_{GS} = 5 \ V \$ Total Gate Charge $V_{SS} = 5 \ V \$ Gate-Source Charge $V_{GS} = 5 \ V \$ murce Diode Characteristics and Maximum RatingsMaximum Continuous Drain-Source Diode Forward CurrentTurn-Drain-Source Diode Forward CurrentTurn-Dra	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Coefficient       IP = 230 µA, Reference to 0.25 C        0.05          Zero Gate Voltage Drain Current $V_{DS} = 60 \vee, V_{GS} = 0 \vee$ 1         Gate-Body Leakage Current, Forward $V_{GS} = 20 \vee, V_{DS} = 0 \vee$ 100         Gate-Body Leakage Current, Reverse $V_{GS} = 20 \vee, V_{DS} = 0 \vee$ 100         acteristics         Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$ 1.0        2.5         Static Drain-Source $V_{GS} = 10 \vee, I_D = 1.4 A$ 0.088       0.11         On-Resistance $V_{GS} = 5 \vee, I_D = 1.4 A$ 0.110       0.14         Forward Transconductance $V_{DS} = 25 \vee, V_{GS} = 0 \vee,$ 4.1          Characteristics         Input Capacitance $V_{DS} = 25 \vee, V_{GS} = 0 \vee,$ 270       350         Output Capacitance $V_{DS} = 25 \vee, V_{GS} = 0 \vee,$ 270       350         Input Capacitance $V_{DS} = 25 \vee, V_{GS} = 0 \vee,$ 270       350         Characteristics       Input Capacitance $V_{DS} = 25 \Omega$ 17

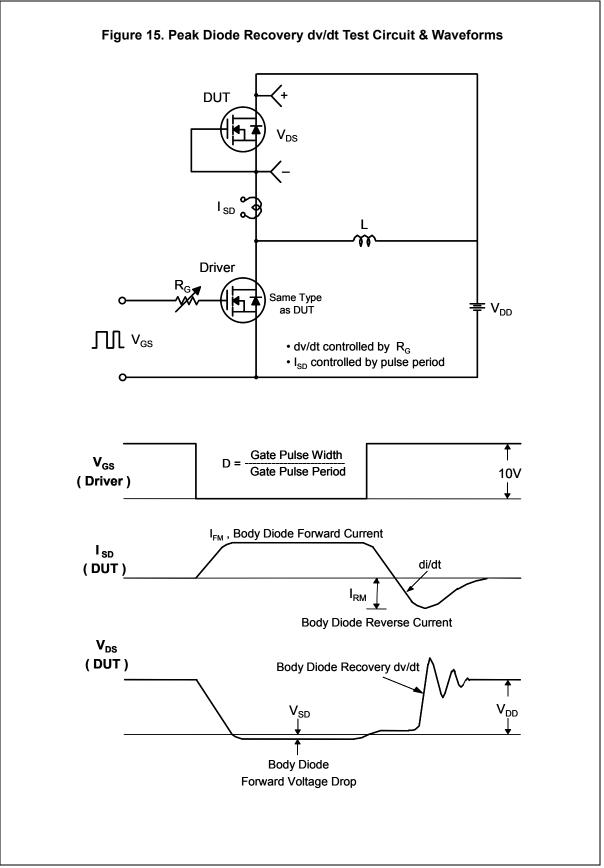
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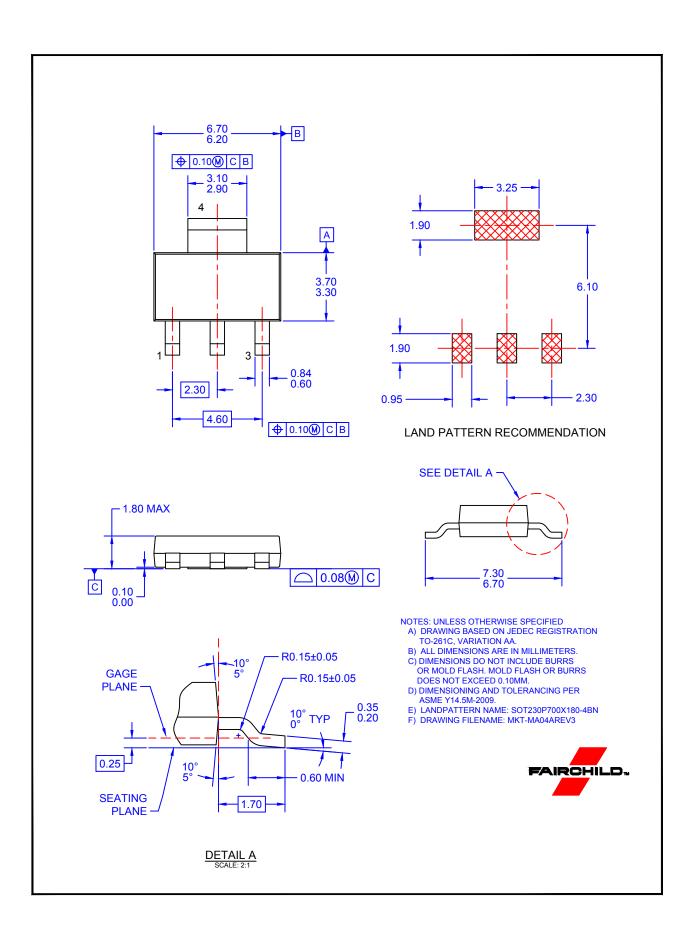




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